

XP132A1545SR

ETR1109_001

Power MOSFET

■ GENERAL DESCRIPTION

The XP132A1545SR is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

The small SOP-8 package makes high density mounting possible.

■ APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■ FEATURES

Low On-State Resistance : $R_{ds(on)}=0.03\Omega$ ($V_{gs}=-10V$)

: $R_{ds(on)}=0.045\Omega$ ($V_{gs}=-4.5V$)

Ultra High-Speed Switching

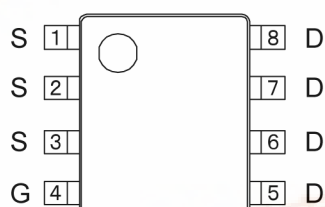
Driving Voltage : $-4.5V$

P-Channel Power MOSFET

DMOS Structure

Package : SOP-8

■ PIN CONFIGURATION

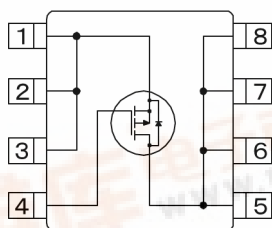


SOP-8
(TOP VIEW)

■ PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1~3	S	Source
4	G	Gate
5~8	D	Drain

■ EQUIVALENT CIRCUIT



P-channel MOSFET
(1 device built-in)

■ ABSOLUTE MAXIMUM RATINGS

$T_a = 25^\circ C$

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	V_{ds}	-30	V
Gate-Source Voltage	V_{gs}	± 20	V
Drain Current (DC)	I_d	-8	A
Drain Current (Pulse)	I_{dp}	-32	A
Reverse Drain Current	I_{dr}	-8	A
Channel Power Dissipation *	P_d	2.5	W
Channel Temperature	T_{ch}	150	$^\circ C$
Storage Temperature Range	T_{stg}	-55~150	$^\circ C$

* When implemented on a glass epoxy PCB

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ELECTRICAL CHARACTERISTICS

DC Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	Idss	Vds=-30V, Vgs=0V	-	-	-10	μA
Gate-Source Leak Current	Igss	Vgs=±20V, Vds=0V	-	-	±1	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id=-1mA, Vds=-10V	-1.0	-	-2.5	V
Drain-Source On-State Resistance *	Rds(on)	Id=-4A, Vgs=-10V	-	0.025	0.030	Ω
		Id=-4A, Vgs=-4.5V	-	0.038	0.045	Ω
Forward Transfer Admittance *	Yfs	Id=-4A, Vds=-10V	-	11	-	S
Body Drain Diode Forward Voltage	Vf	If=-8A, Vgs=0V	-	-0.85	-1.1	V

* Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds=-10V, Vgs=0V f=1MHz	-	1500	-	pF
Output Capacitance	Coss		-	1000	-	pF
Feedback Capacitance	Crss		-	500	-	pF

Switching Characteristics

Ta = 25°C

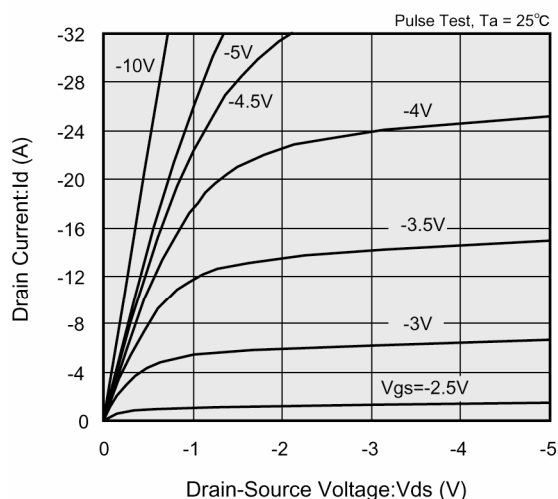
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs=-5V, Id=-4A Vdd=-10V	-	20	-	ns
Rise Time	tr		-	45	-	ns
Turn-Off Delay Time	td (off)		-	40	-	ns
Fall Time	tf		-	35	-	ns

Thermal Characteristics

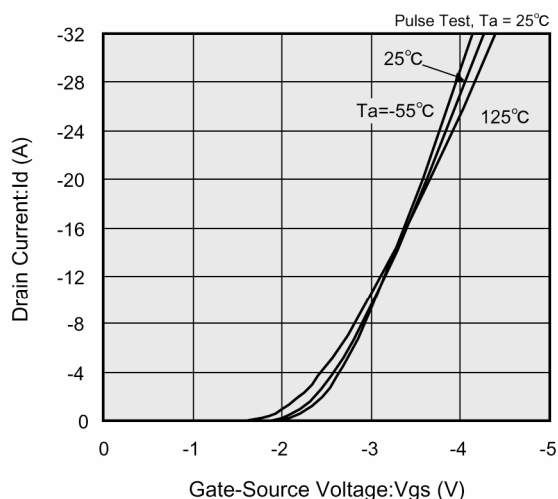
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	50	-	°C/W

TYPICAL PERFORMANCE CHARACTERISTICS

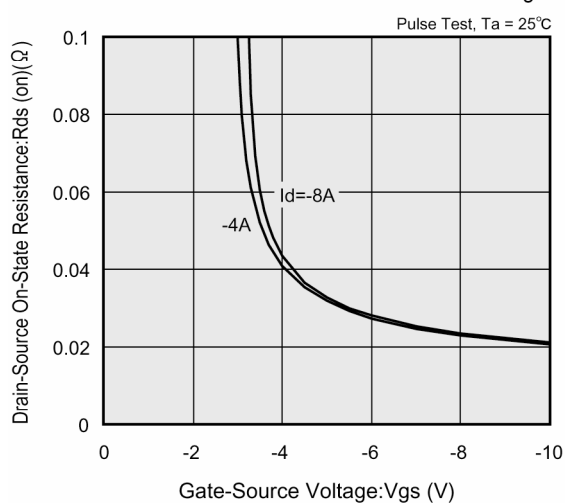
(1) Drain Current vs. Drain-Source Voltage



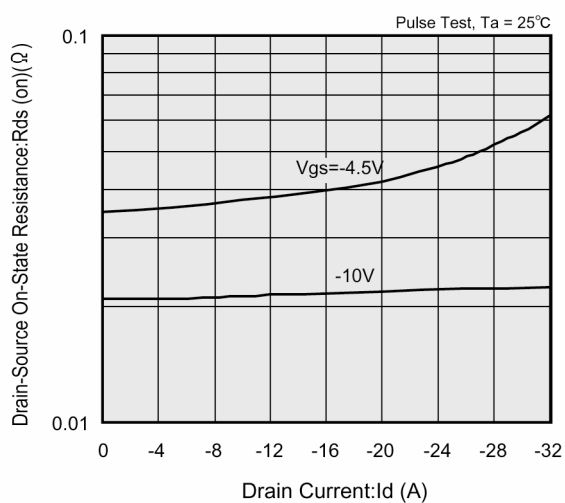
(2) Drain Current vs. Gate-Source Voltage



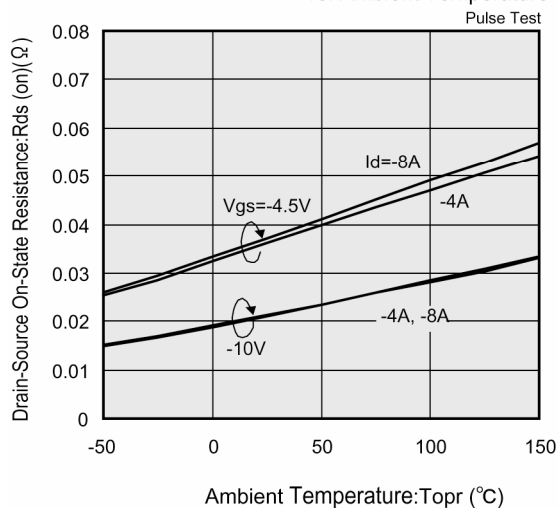
(3) Drain-Source On-State Resistance vs. Gate-Source Voltage



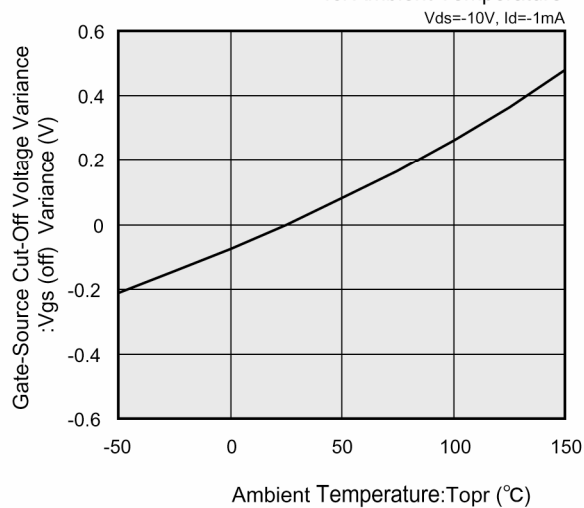
(4) Drain-Source On-State Resistance vs. Drain Current



(5) Drain-Source On-State Resistance vs. Ambient Temperature



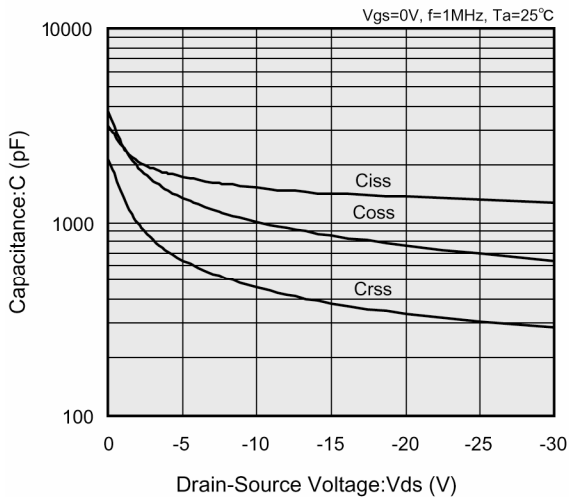
(6) Gate-Source Cut-Off Voltage Variance vs. Ambient Temperature



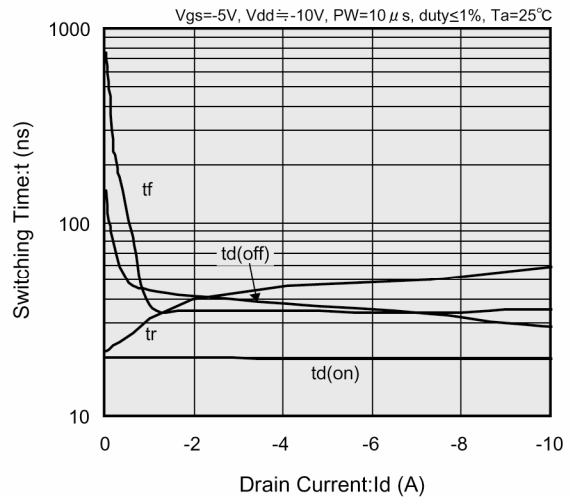
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TYPICAL PERFORMANCE CHARACTERISTICS (Cotinued)

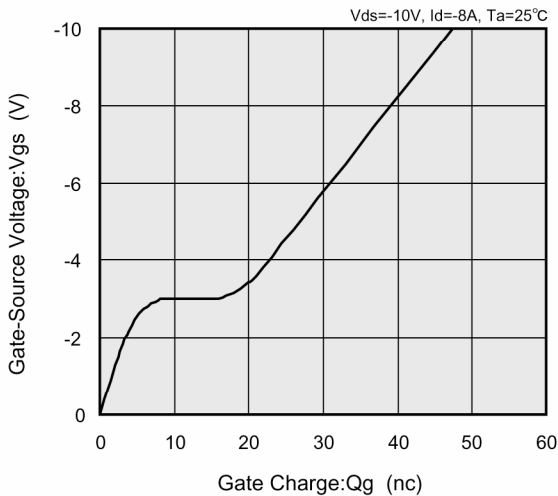
(7) Capacitance vs. Drain-Source Voltage



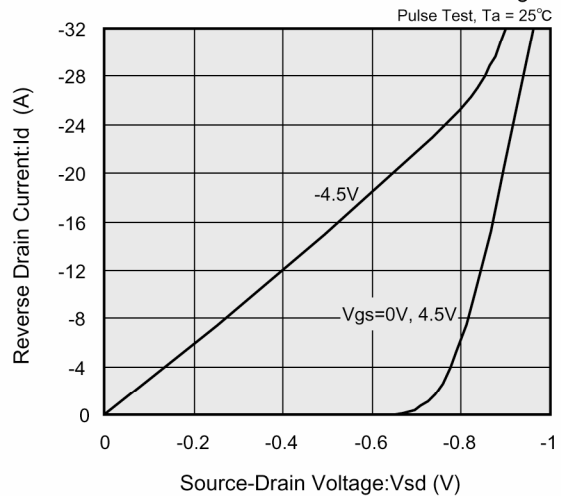
(8) Switching Time vs. Drain Current



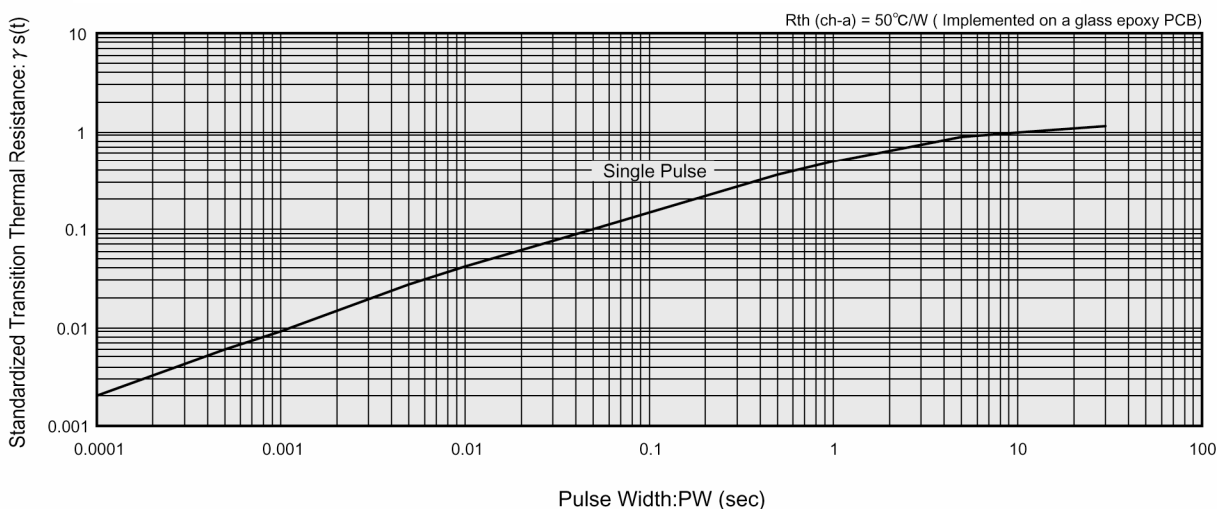
(9) Gate-Source Voltage vs. Gate Charge



(10) Reverse Drain Current vs. Source-Drain Voltage



(11) Standardized transition Thermal Resistance vs. Pulse Width



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